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Small signal Schottky diodes

Features

- Low conduction and reverse losses
- Negligible switching losses
- Low forward and reverse recovery times
- Extremely fast switching
- Surface mount device
- Low capacitance diode

Description

The BAT54 series uses 40 V Schottky barrier diodes packaged in SOD- 23, SOD-323, SOD-523, SOT-23, SOT-323, or SOT-666.

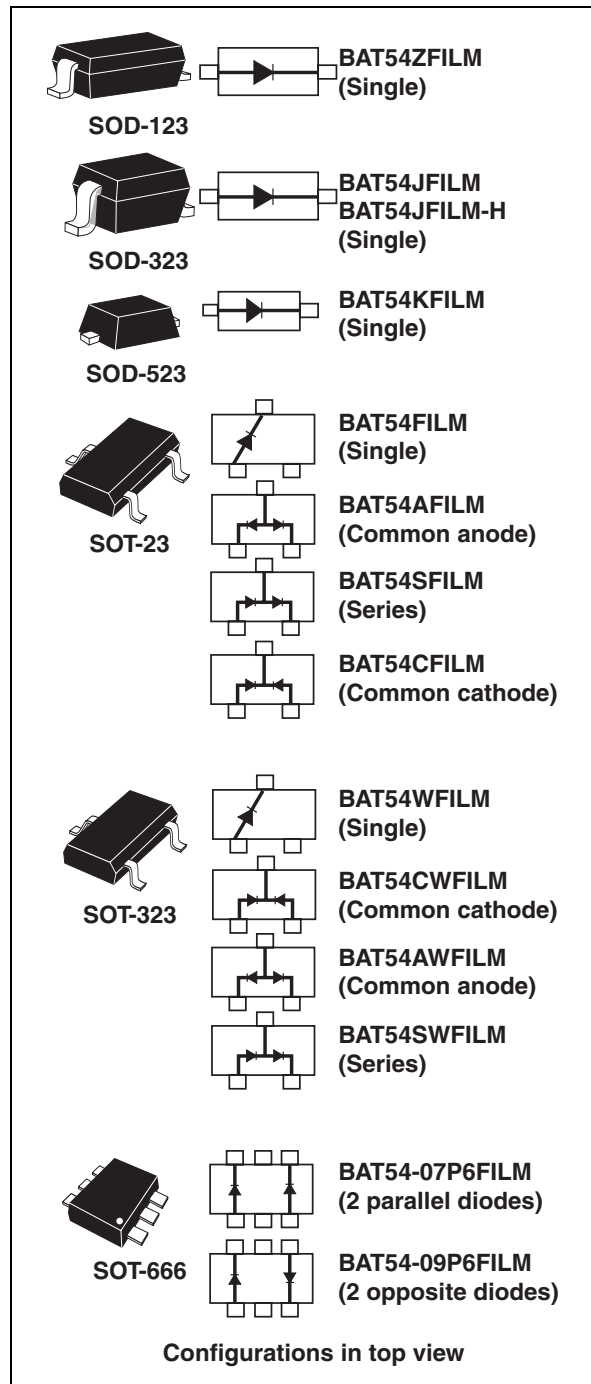


Table 1. Device summary

Symbol	Value
I_F	300 mA
V_{RRM}	40 V
C (typ)	7 pF
T_j (max)	150 °C

1 Characteristics

Table 2. Absolute ratings (limiting values at T_j = 25 °C, unless otherwise specified)

Symbol	Parameter	Value	Unit
V _{RRM}	Repetitive peak reverse voltage	40	V
I _F	Continuous forward current	300	mA
I _{FSM}	Surge non repetitive forward current	t _p = 10 ms Sinusoidal	1
T _{stg}	Storage temperature range	-65 to +150	°C
T _j	Operating junction temperature range	-40 to +150	°C
T _L	Maximum soldering temperature	260	°C

Table 3. Thermal parameters

Symbol	Parameter	Value	Unit
R _{th(j-a)}	Junction to ambient ⁽¹⁾	SOT-23, SOD-123	500
		SOT-323, SOD-323,	550
		SOD-523, SOT-666	600

1. Epoxy printed circuit board with recommended pad layout

Table 4. Static electrical characteristics

Symbol	Parameter	Test conditions	Min.	Typ.	Max.	Unit
I _R ⁽¹⁾	Reverse leakage current	T _j = 25 °C	V _R = 30 V		1	μA
		T _j = 100 °C			100	
V _F ⁽²⁾	Forward voltage drop	T _j = 25 °C	I _F = 0.1 mA		240	mV
			I _F = 1 mA		320	
			I _F = 10 mA		400	
			I _F = 30 mA		500	
			I _F = 100 mA		900	

1. Pulse test: t_p = 5 ms, δ < 2 %

2. Pulse test: t_p = 380 μs, δ < 2 %

Table 5. Dynamic characteristics

Symbol	Parameter	Test conditions	Min.	Typ.	Max.	Unit
C	Diode capacitance	V _R = 1 V, F = 1 MHz		7	10	pF
t _{rr}	Reverse recovery time	I _F = 10 mA, I _R = 10 mA, T _j = 25 °C I _{rr} = 1 mA, R _L = 100 Ω			5	ns

Figure 1. Average forward power dissipation versus average forward current

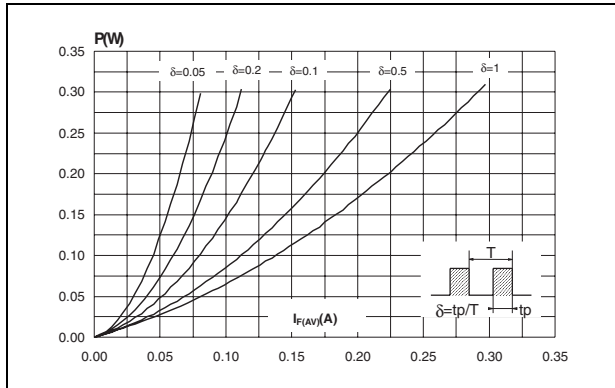


Figure 2. Average forward current versus ambient temperature (delta = 1)

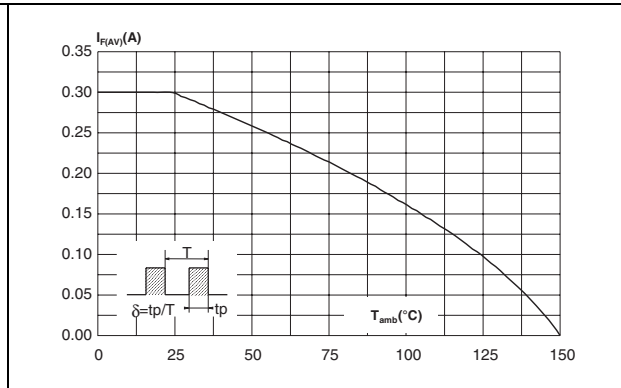


Figure 3. Reverse leakage current versus reverse applied voltage (typical values)

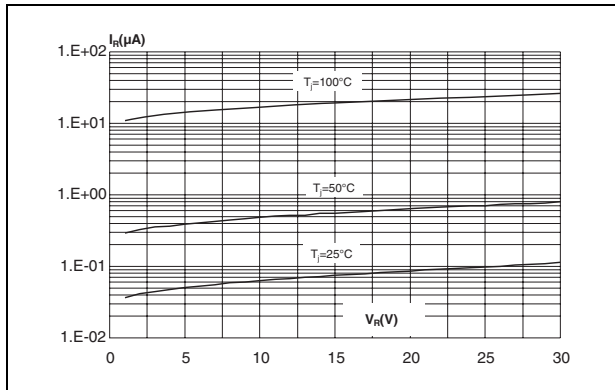


Figure 4. Reverse leakage current versus junction temperature

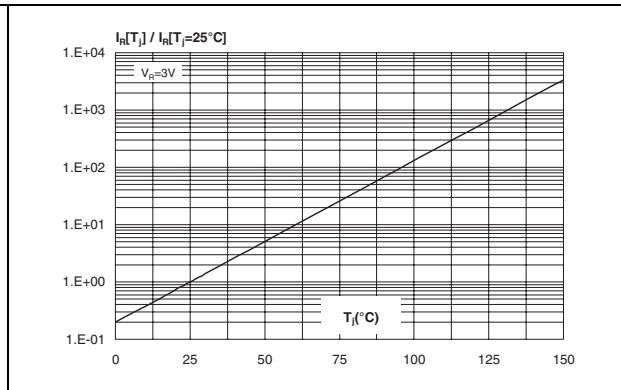


Figure 5. Junction capacitance versus reverse applied voltage (typical values)

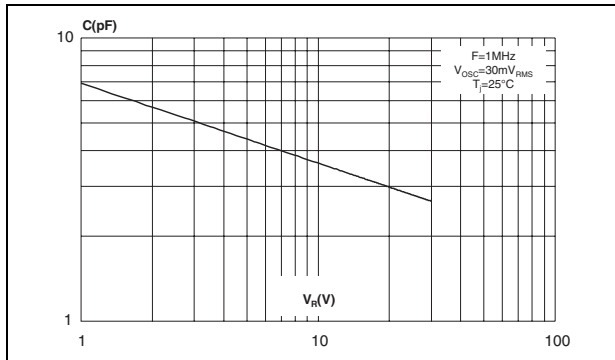


Figure 6. Forward voltage drop versus forward current (typical values)

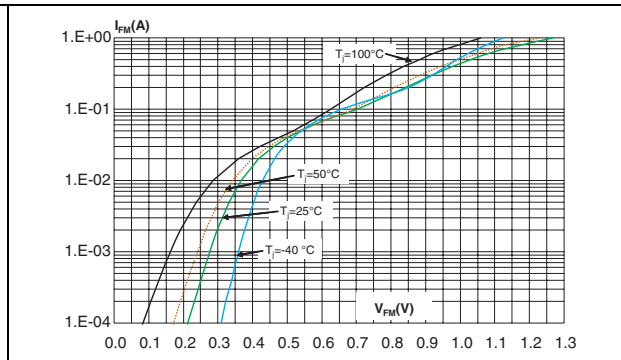


Figure 7. Thermal resistance junction to ambient versus copper surface under each lead (SOD-323)

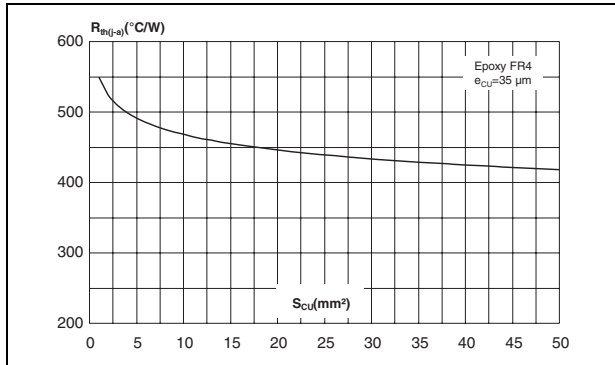


Figure 8. Relative variation of thermal impedance junction to ambient versus pulse duration (SOD-323)

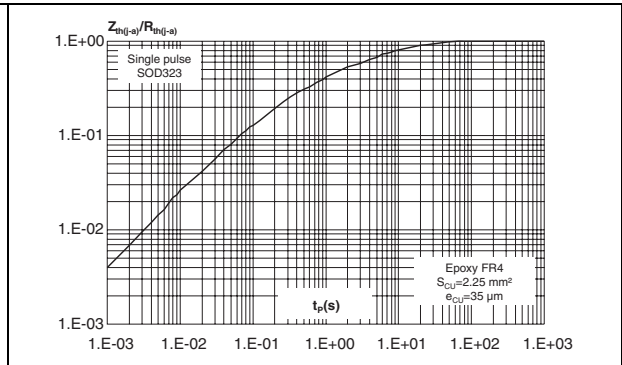


Figure 9. Relative variation of thermal impedance junction to ambient versus pulse duration (SOT-23)

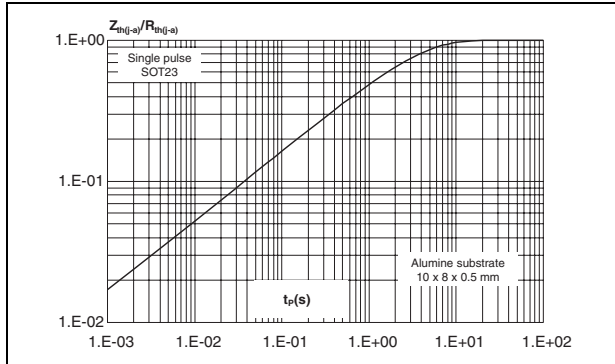


Figure 10. Relative variation of thermal impedance junction to ambient versus pulse duration (SOD-523)

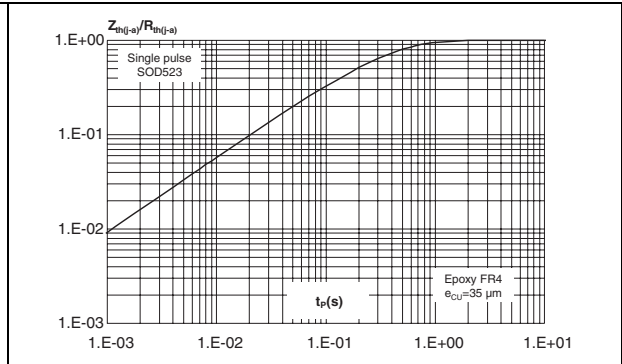
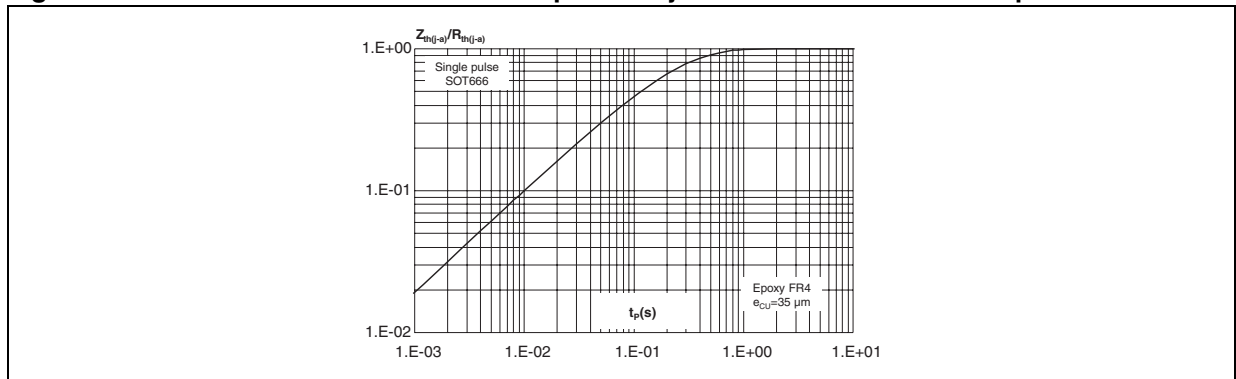
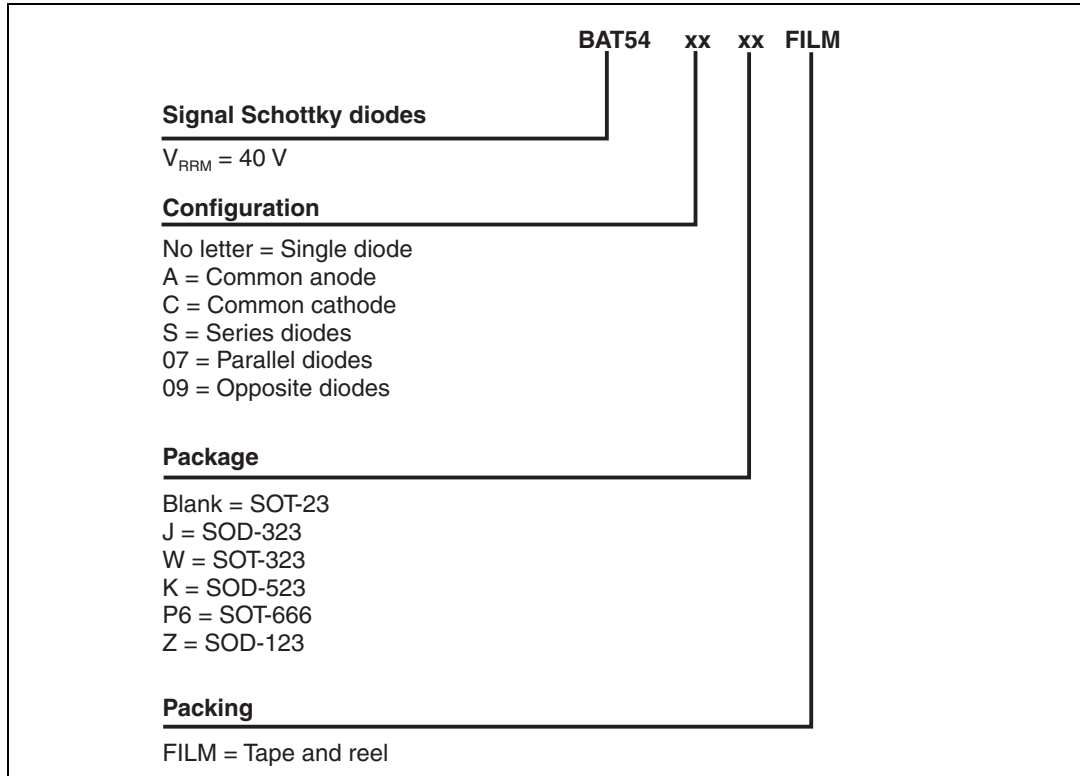


Figure 11. Relative variation of thermal impedance junction to ambient versus pulse duration



2 Ordering information scheme

Figure 12. Ordering information scheme



3 Package information

- Epoxy meets UL94, V0
- Lead-free packages

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK® packages, depending on their level of environmental compliance. ECOPACK® specifications, grade definitions and product status are available at: www.st.com. ECOPACK® is an ST trademark.

Table 6. SOD-123 dimensions

Ref.	Dimensions			
	Millimeters		Inches	
	Min.	Max.	Min.	Max.
A		1.45		0.057
A1	0	0.1	0	0.004
A2	0.85	1.35	0.033	0.053
b	0.55 Typ.		0.022 Typ.	
c	0.15 Typ.		0.039 Typ.	
D	2.55	2.85	0.1	0.112
E	1.4	1.7	0.055	0.067
G	0.25		0.01	
H	3.55	3.95	0.14	0.156

Figure 13. SOD-123 footprint (dimensions in mm)

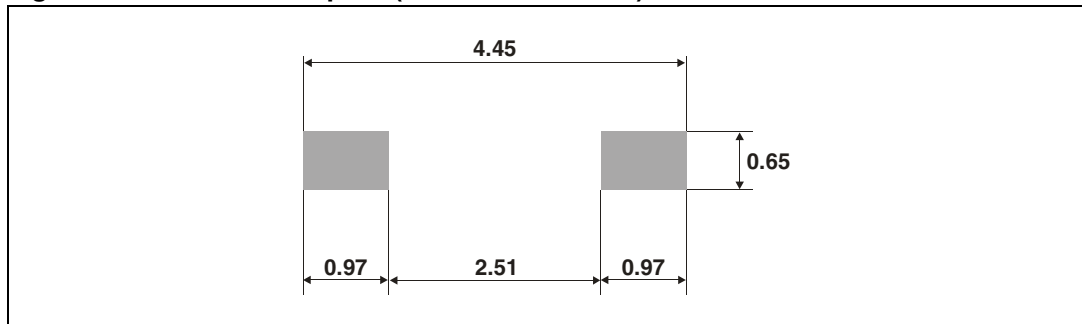


Table 7. SOD-323 dimensions

Ref.	Dimensions			
	Millimeters		Inches	
	Min.	Max.	Min.	Max.
A		1.17		0.046
A1	0	0.1	0	0.004
b	0.25	0.44	0.01	0.017
c	0.1	0.25	0.004	0.01
D	1.52	1.8	0.06	0.071
E	1.11	1.45	0.044	0.057
H	2.3	2.7	0.09	0.106
L	0.1	0.46	0.004	0.02
Q1	0.1	0.41	0.004	0.016

Figure 14. SOD-323 footprint (dimensions in mm)

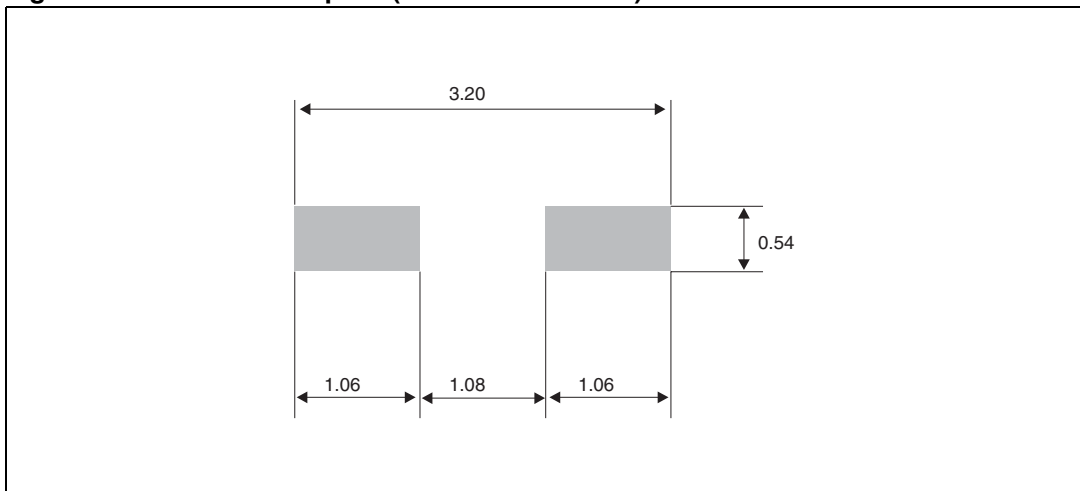


Table 8. SOD-523 dimensions

Ref.	Dimensions					
	Millimeters			Inches		
	Min.	Typ.	Max.	Min.	Typ.	Max.
A	0.50	0.60	0.70	0.020	0.024	0.028
E	1.50	1.60	1.70	0.059	0.063	0.067
E1	1.10	1.20	1.30	0.043	0.047	0.051
D	0.70	0.80	0.90	0.028	0.031	0.035
b	0.25		0.35	0.010		0.014
c	0.07		0.20	0.003		0.008
L	0.15	0.20	0.25	0.006	0.008	0.010
L1	0.05		0.20	0.002		0.008

Figure 15. SOD-523 footprint (dimensions in mm)

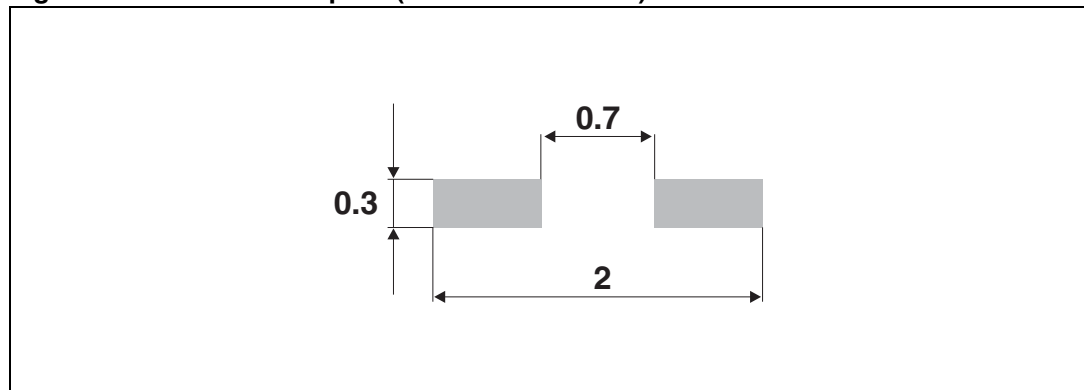


Table 9. SOT-23 dimensions

Ref.	Dimensions			
	Millimeters		Inches	
	Min.	Max.	Min.	Max.
A	0.89	1.4	0.035	0.055
A1	0	0.1	0	0.004
B	0.3	0.51	0.012	0.02
c	0.085	0.18	0.003	0.007
D	2.75	3.04	0.108	0.12
e	0.85	1.05	0.033	0.041
e1	1.7	2.1	0.067	0.083
E	1.2	1.6	0.047	0.063
H	2.1	2.75	0.083	0.108
L	0.6 typ.		0.024 typ.	
S	0.35	0.65	0.014	0.026

Figure 16. SOT-23 footprint (dimensions in mm)

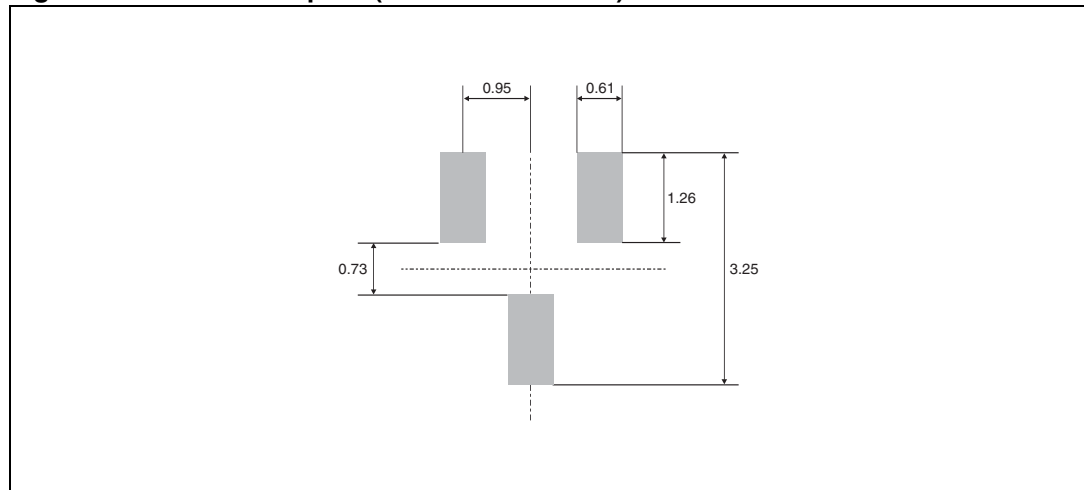


Table 10. SOT-323 dimensions

Ref.	Dimensions					
	Millimeters			Inches		
	Min.	Typ.	Max.	Min.	Typ.	Max.
A	0.8		1.1	0.031		0.043
A1	0.0		0.1	0.0		0.004
b	0.25		0.4	0.010		0.016
c	0.1		0.26	0.004		0.010
D	1.8	2.0	2.2	0.071	0.079	0.086
E	1.15	1.25	1.35	0.045	0.049	0.053
e		0.65			0.026	
H	1.8	2.1	2.4	0.071	0.083	0.094
L	0.1	0.2	0.3	0.004	0.008	0.012
q	0		30°	0		30°

Figure 17. SOT-323 footprint (dimensions in mm)

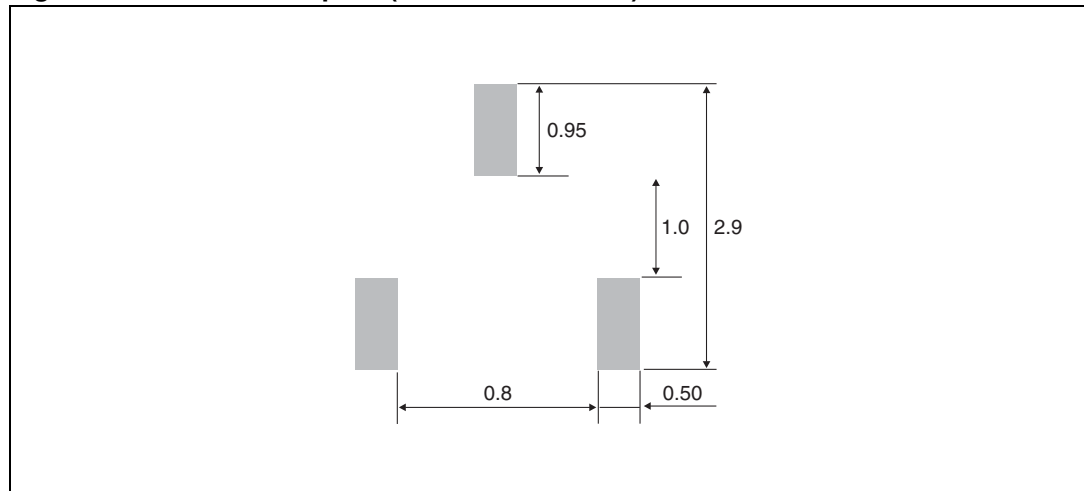
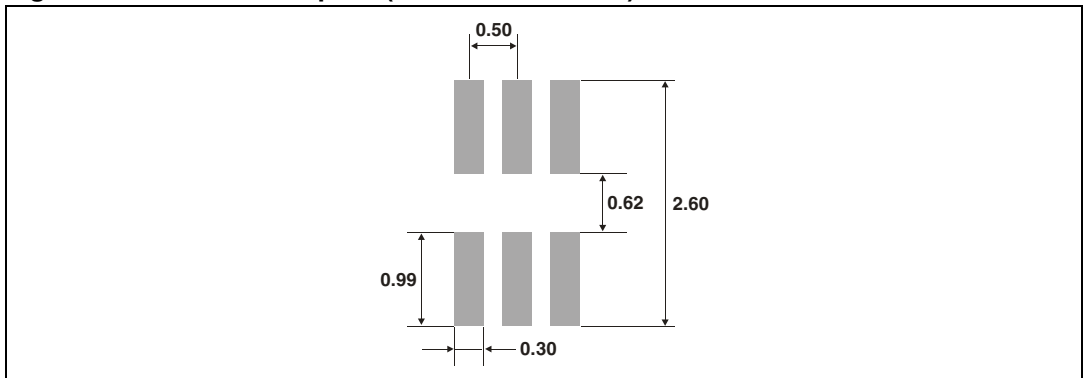


Table 11. SOT-666 dimensions

Ref.	Dimensions					
	Millimeters			Inches		
	Min.	Typ.	Max.	Min.	Typ.	Max.
A	0.45		0.60	0.018		0.024
A3	0.08		0.18	0.003		0.007
b	0.17		0.34	0.007		0.013
b1	0.19	0.27	0.34	0.007	0.011	0.013
D	1.50		1.70	0.059		0.067
E	1.50		1.70	0.059		0.067
E1	1.10		1.30	0.043		0.051
e		0.50			0.020	
L1		0.19			0.007	
L2	0.10		0.30	0.004		0.012
L3		0.10			0.004	

Figure 18. SOT-666 footprint (dimensions in mm)



4 Ordering information

Table 12. Ordering information

Order code	Marking	Package	Weight	Base qty	Delivery mode
BAT54FILM	D86	SOT-23 Single	10 mg	3000	Tape and reel
BAT54SFILM	D88	SOT-23 Serial	10 mg	3000	Tape and reel
BAT54CFILM	D87	SOT-23 Common cathode	10 mg	3000	Tape and reel
BAT54AFILM	D84	SOT-23 Common anode	10 mg	3000	Tape and reel
BAT54WFILM	D73	SOT-323 Single	6 mg	3000	Tape and reel
BAT54SWFILM	D78	SOT-323 Serial	6 mg	3000	Tape and reel
BAT54CWFILM	D77	SOT-323 Common cathode	6 mg	3000	Tape and reel
BAT54AWFILM	D74	SOT-323 Common anode	6 mg	3000	Tape and reel
BAT54JFILM	86	SOD-323	5 mg	3000	Tape and reel
BAT54JFILM-H	86	SOD-323 ECOPACK [®] 2 halogen-free	5 mg	3000	Tape and reel
BAT54KFILM	86	SOD-523	1.4 mg	3000	Tape and reel
BAT54-07P6FILM	P4	SOT-666 Parallel	2.9 mg	3000	Tape and reel
BAT54-09P6FILM	Q4	SOT-666 Opposite	2.9 mg	3000	Tape and reel
BAT54ZFILM	D72	SOD-123	10 mg	3000	Tape and reel

5 Revision history

Table 13. Document revision history

Date	Revision	Changes
Jun-1999	8	Last update.
24-Jul-2006	9	BAT54, A, C, S and BAT54J / W / AW / CW /SW datasheets merged. ECOPACK statement added. SOD-123, SOD-523 and SOT-666 packages added.
13-Oct-2009	10	Updated Table 8 quote "L1" from 0.10 to 0.05.

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